TMPIM 25 A CIB Module

NXH25C120L2C2SG

The NXH25C120L2C2SG is a transfer-molded power module containing a converter-inverter-brake circuit consisting of six 25 A, 1600 V rectifiers, six 25 A, 1200 V IGBTs with inverse diodes, one 25 A, 1200 V brake IGBT with brake diode and an NTC thermistor.

Features

- Low Thermal Resistance
- 6 mm Clearance Distance between Pin to Heatsink
- Compact 73 mm × 40 mm × 8 mm Package
- Solderable Pins
- Thermistor
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Industrial Motor Drives
- Servo Drives

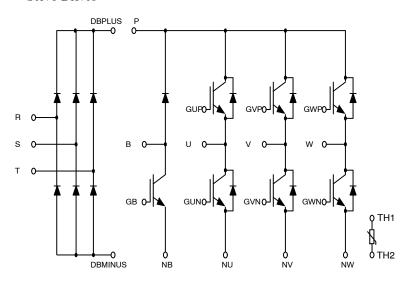
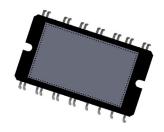


Figure 1. NXH25C120L2C2SG Schematic Diagram



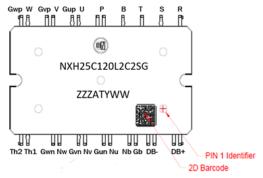
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DIP26 67.8x40 CASE 181AD

MARKING DIAGRAM



NXH25C120L2C2SG	= Specific Device Code
ZZZ	= Assembly Lot Code
AT	= Assembly & Test Location
Υ	= Year
WW	= Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]
NXH25C120L2C2SG	DIP26 (Pb-Free)	6 Units / Tube

MAXIMUM RATINGS

Rating	Symbol	Value	Unit			
IGBT	•	•				
Collector-Emitter Voltage	V _{CES}	1200	V			
Gate-Emitter Voltage	V _{GE}	±20	V			
Continuous Collector Current @ T _C = 80°C (Tv _{Jmax} = 175°C)	I _C	25	Α			
Pulsed Collector Current	I _{Cpulse}	75	Α			
DIODE						
Peak Repetitive Reverse Voltage	V_{RRM}	1200	V			
Continuous Forward Current @ T _C = 80°C (Tv _{Jmax} = 175°C)	I _F	25	Α			
Repetitive Peak Forward Current	I _{FRM}	75	Α			
RECTIFIER DIODE						
Peak Repetitive Reverse Voltage	V_{RRM}	1600	V			
Continuous Forward Current @ T _C = 80°C (Tv _{Jmax} = 150°C)	I _F	25	Α			
Repetitive Peak Forward Current	I _{FRM}	75	Α			
l ² t value (10 ms single half–sine wave) @ 25°C (10 ms single half–sine wave) @ 150°C	l ² t	680 360	A ² t			
Surge current (10 ms sin180°) @ 25°C	IFSM	370	Α			
THERMAL PROPERTIES						
Storage Temperature range	T _{stg}	-40 to 125	°C			
INSULATION PROPERTIES						
Isolation test voltage, t = 1 sec, 50 Hz	V _{is}	3000	V _{RMS}			
Internal isolation		Al ₂ O ₃				
Creepage distance		6.0	mm			
Clearance distance		6.0	mm			
Comperative Tracking Index	СТІ	> 400				

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe

Operating parameters.

ELECTRICAL CHARACTERISTICS (T_{.I} = 25°C unless otherwise specified)

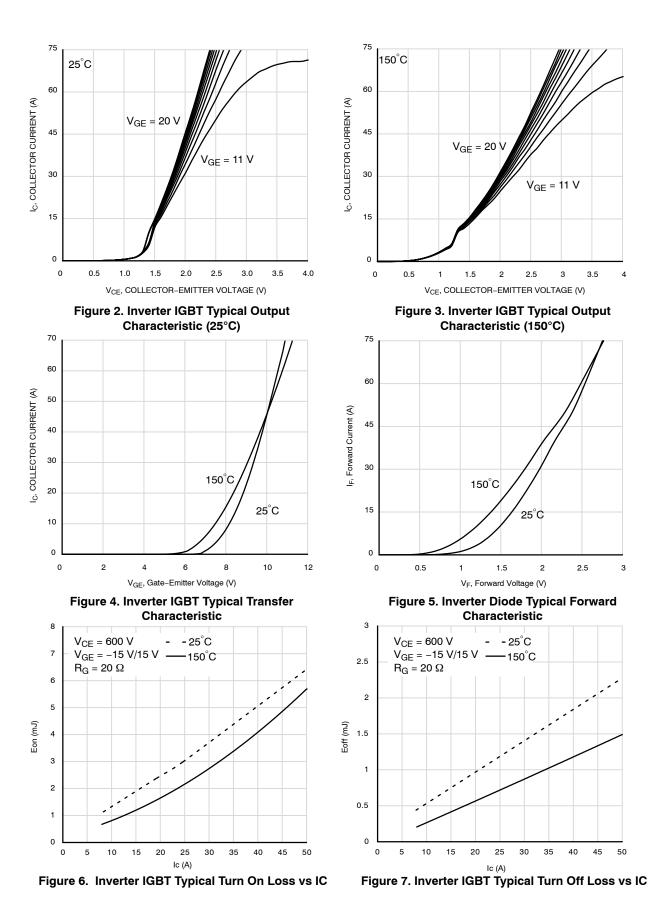
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
IGBT CHARACTERISTICS				•	•	•
Collector-Emitter Cutoff Current	V _{GE} = 0 V, V _{CE} = 1200 V	I _{CES}	-	_	250	μΑ
Collector-Emitter Saturation Voltage	V _{GE} = 15 V, I _C = 25 A, T _J = 25°C	V _{CE(sat)}	-	1.7	2.4	V
	V _{GE} = 15 V, I _C = 25 A, T _J = 150°C		_	1.9	_	
Gate-Emitter Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 3.04$ mA	V _{GE(TH)}	4.8	5.9	6.8	V
Gate Leakage Current	V _{GE} = 20 V, V _{CE} = 0 V	I _{GES}	-	-	400	nA
Turn-on Delay Time	T _J = 25 °C	t _{d(on)}	-	68	-	ns
Rise Time	V _{CE} = 600 V, I _C = 25 A	t _r	-	63	_	1
Turn-off Delay Time	$V_{GE} = \pm 15 \text{ V}, R_{G} = 20 \Omega$	t _{d(off)}	-	235	_	1
Fall Time	1	t _f	-	48	_	1
Turn-on Switching Loss per Pulse	1	E _{on}	-	2200	_	μJ
Turn off Switching Loss per Pulse	1	E _{off}	-	720	_	1
Turn-on Delay Time	T _J = 125°C	t _{d(on)}	-	72	_	ns
Rise Time	V _{CE} = 600 V, I _C = 25 A	t _r	-	56	_	
Turn-off Delay Time	$V_{GE} = \pm 15 \text{ V}, R_{G} = 20 \Omega$	t _{d(off)}	_	266	_	
Fall Time	1	t _f	_	54	_	1
Turn-on Switching Loss per Pulse	1	E _{on}	-	3050	_	μJ
Turn off Switching Loss per Pulse	1	E _{off}	-	1200	_	1
Input Capacitance	V _{CE} = 20 V. V _{GE} = 0 V	C _{ies}	-	6200	_	pF
Output Capacitance	f = 100 kHz	C _{oes}	-	212	_	1
Reverse Transfer Capacitance	1	C _{res}	-	117	_	1
Total Gate Charge	$V_{CE} = 600 \text{ V}, I_{C} = 25 \text{ A}, V_{GE} = 0 \text{ V} \sim +15 \text{ V}$	Qg	-	269	-	nC
Temperature under switching conditions		Tvj op	-40		150	°C
Thermal Resistance - chip-to-case		RthJC	=	0.54	=	°C/W
DIODE CHARACTERISTICS					<u>I</u>	
Brake Diode Reverse Leakage Current	V _R = 1200 V	I _R	=	-	200	μΑ
Diode Forward Voltage	I _F = 25 A, T _J = 25°C	V _F	_	1.9	2.6	V
	I _F = 25 A, T _J = 150°C		-	1.7	_	1
Reverse Recovery Charge	T _J = 25°C	Q _{rr}	_	1.35	_	μС
Peak Reverse Recovery Current	$V_{CE} = 600 \text{ V}, I_{C} = 25 \text{ A}$	I _{RRM}	_	16	_	Α
Reverse Recovery Energy	$V_{GE} = \pm 15 \text{ V}, R_{G} = 20 \Omega$	E _{rr}	=	350	=	μJ
Reverse Recovery Charge	T _J = 150 °C	Q _{rr}	_	3.6	_	μC
Peak Reverse Recovery Current	V _{CE} = 600 V, I _C = 25 A	I _{RRM}	-	26	=	Α
Reverse Recovery Energy	V_{GE} = ±15 V, R_{G} = 20 Ω	E _{rr}	=	1050	=	μJ
Temperature under switching conditions		Tvj op	-40		150	°C
Thermal Resistance - chip-to-case		RthJC	_	1.10		°C/W

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified) (continued)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
RECTIFIER DIODE CHARACTERISTICS	<u> </u>	•		•	•	•
Rectifier Reverse Leakage Current	V _R = 1600 V	I _R	_		200	μА
Rectifier Forward Voltage	I _F = 25 A, T _J = 25°C	V _F	-	1	1.5	V
	I _F = 35 A, T _J = 150°C		=	1.1	-]
Temperature under switching conditions		Tvj op	-40		150	°C
Thermal Resistance - chip-to-case		RthJC	_	0.86	_	°C/W
THERMISTOR CHARACTERISTICS			•	•	•	•
Nominal resistance	T = 25°C	R ₂₅	=	5	=	kΩ
Nominal resistance	T = 100°C	R ₁₀₀	_	493.3	_	Ω
Deviation of R25		∆R/R	-5	-	5	%
Power dissipation		P _D	_	20	_	mW
Power dissipation constant			_	1.4	_	mW/K
B-value	B(25/50), tolerance ±2%		_	3375		K
B-value	B(25/100), tolerance ±2%		-	3433	_	K

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS - INVERTER/BRAKE IGBT & DIODE



TYPICAL CHARACTERISTICS - INVERTER/BRAKE IGBT & DIODE

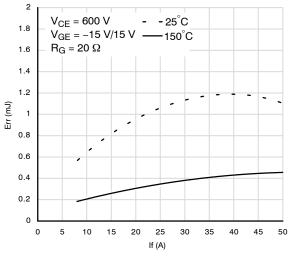


Figure 8. Inverter Diode Typical Reverse Recovery Energy vs IC

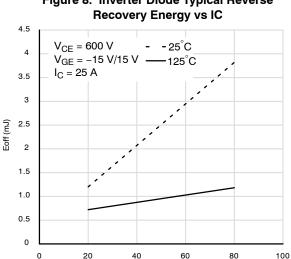


Figure 10. Inverter IGBT Typical Turn Off Loss vs RG

Rg (Ω)

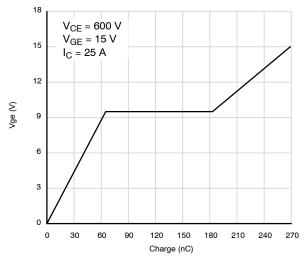


Figure 12. Inverter IGBT Gate Voltage vs Gate Charge

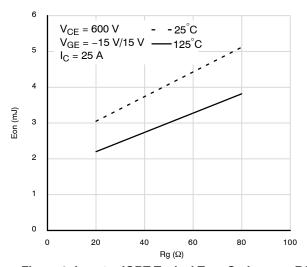


Figure 9. Inverter IGBT Typical Turn On Loss vs RG

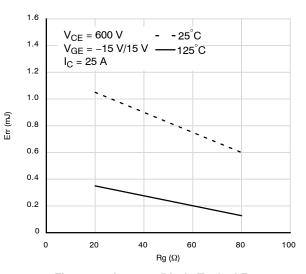


Figure 11. Inverter Diode Typical Reverse Recovery Energy vs RG

TYPICAL CHARACTERISTICS - INVERTER/BRAKE IGBT & DIODE

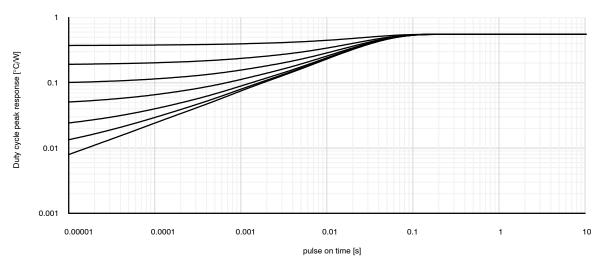


Figure 13. IGBT Junction-to-Case Transient Thermal Impedance

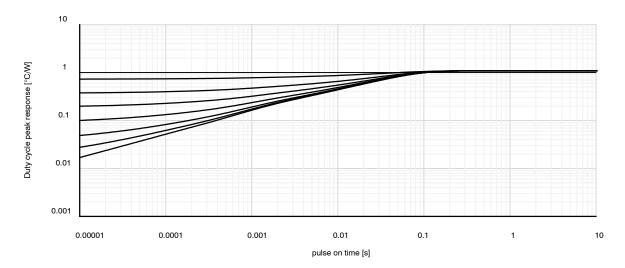


Figure 14. Diode Junction-to-Case Transient Thermal Impedance

TYPICAL CHARACTERISTICS - RECTIFIER

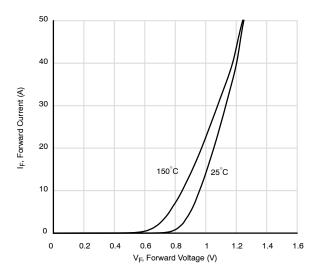


Figure 15. Rectifier Typical Forward Characteristic

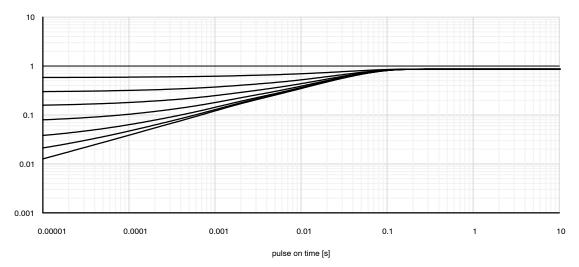
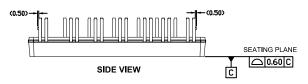


Figure 16. Rectifier Junction-to-Case Transient Thermal Impedance



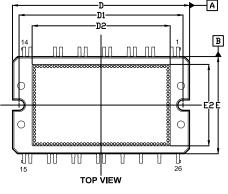
DIP26 67.8x40 CASE 181AD **ISSUE B**

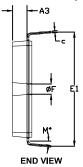
DATE 05 AUG 2021

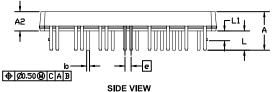


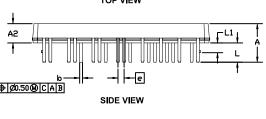


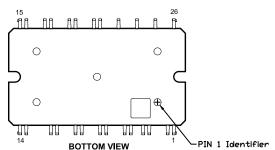
- Dimensioning and tolerancing as per ASME Y14.5M, 2009 1.
- Controlling Dimension: Millimeters 2.
- 3. Dimensions are exclusive of Burrs, Mold Flash, and Tiebar extrusions
- 4. Dimensions "b" and "c" apply to plated leads
- 5. Position of the leads is determine at the root of the lead where it exits the package body











DIM	М	LLIMETER	METERS		
DIN	MIN	NOM	MAX		
Α	15.50	16.00	16.50		
A2	7.80	8.00	8.20		
A3		6.00 REF			
b	1.10	1.20	1.30		
С	0.70	0.80	0.90		
D	72.70	73.20	73.70		
D1	67.30	67.80	68.30		
D2		57.30 REF			
E	39.70	70 40.20 40.7			
E1	46.70	47.20	47.70		
E2	;	33.87 REF			
е	2.54 BSC				
F	4.00	4.20	4.40		
L	8.00 REF				
L1	3.50	4.00	4.50		
М	4°	5°	6°		

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

ZZZ = Assembly Lot Code

= Assembly & Test Location

= Year

WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

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FF100R12KS4 FF200R06KE3 FF200R06YE3 FF300R06KE3_B2 FF300R17ME4 FF600R12IP4V FF800R17KP4_B2 FF900R12IE4V
FP100R07N3E4 FP100R07N3E4_B11 FP10R06W1E3_B11 FP10R12W1T4_B11 FP10R12YT3 FP15R12YT3 FP20R06W1E3
FP30R06W1E3 FP40R12KT3G FP75R06KE3 FS10R12YE3 FS150R07PE4 FS150R12PT4 FS150R17N3E4_B11 FS20R06W1E3_B11
FS30R06W1E3_B11 FS75R12KE3G FS75R12W2T4_B11 FZ1600R17HP4_B2 FZ300R12KE3G FZ400R12KS4 FZ400R17KE3
FZ400R17KE4 FZ600R65KE3 FZ900R12KP4 DF1000R17IE4D_B2 APTGT75DA60T1G DZ800S17K3 F12-25R12KT4G
F3L200R12W2H3_B11 F3L300R12ME4_B22 F3L75R07W2E3_B11 F4-150R12KS4 F475R07W1H3B11ABOMA1 FD1400R12IP4D